

## Radiation Hardened Quad Voltage Comparator

Intersil's Satellite Applications Flow™ (SAF) devices are fully tested and guaranteed to 100kRAD total dose. These QML Class T devices are processed to a standard flow intended to meet the cost and shorter lead-time needs of large volume satellite manufacturers, while maintaining a high level of reliability.

The Radiation Hardened HS-139RH-T consists of four independent single or dual supply voltage comparators on a single monolithic substrate. The common mode input voltage range includes ground, even when operated from a single supply, and the low supply current make these comparators suitable for low power applications. These types were designed to directly interface with TTL and CMOS.

The HS-139RH-T is fabricated on our dielectrically isolated Rad Hard Silicon Gate (RSG) process, which provides an immunity to Single Event Latch-up and the capability of highly reliable performance in any radiation environment.

## Specifications

Specifications for Rad Hard QML devices are controlled by the Defense Supply Center in Columbus (DSCC). The SMD numbers listed below must be used when ordering.

**Detailed Electrical Specifications for the HS-139RH-T are contained in SMD 5962-98613. A "hot-link" is provided on our homepage with instructions for downloading.**

[www.intersil.com/spacedefense/newsafclasst.asp](http://www.intersil.com/spacedefense/newsafclasst.asp)

Intersil' Quality Management Plan (QM Plan), listing all Class T screening operations, is also available on our website.

[www.intersil.com/quality/manuals.asp](http://www.intersil.com/quality/manuals.asp)

## Ordering Information

ORDERING NUMBER	PART NUMBER	TEMP. RANGE (°C)
5962R9861301TCC	HS1-139RH-T	-55 to 125
5962R9861301TXC	HS9-139RH-T	-55 to 125

**NOTE: Minimum order quantity for -T is 150 units through distribution, or 450 units direct.**

## Features

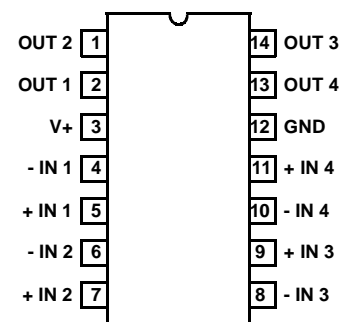
- QML Qualified Per MIL-PRF-38535 Requirements
- Radiation Environment
  - Latch-up Free Under Any Conditions
  - Total Dose . . . . .  $3 \times 10^5$  RAD(Si)
  - SEU LET . . . . . 20MEV/cm<sup>2</sup>/mg
- 100V Output Voltage Withstand Capability
- Differential Input Voltage Range Equal to the Supply Voltage
- Input Offset Voltage ( $V_{IO}$ ) . . . . . .2mV(max)
- Quiescent Supply Current . . . . . .2mA(max)

## Applications

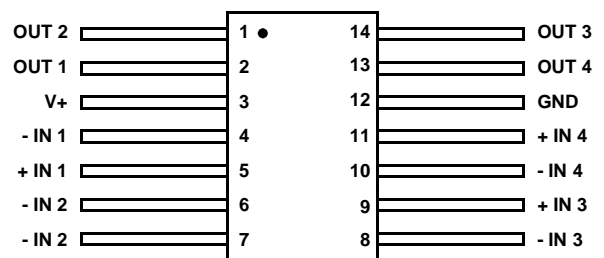
- Pulse Generators
- Timing Circuitry
- Level Shifting
- Analog to Digital Conversion

## Pinouts

**HS-139RH-T (SBDIP), CDIP2-T14**  
TOP VIEW



**HS-139RH-T (FLATPACK), CDFP3-F14**  
TOP VIEW



**Die Characteristics**

**DIE DIMENSIONS:**

3750µm x 2820µm (148 mils x 111 mils)  
 483µm ± 25.4µm (19 mils ± 1 mil)

**INTERFACE MATERIALS**

**Glassivation**

Type: Nitride (Si<sub>3</sub>N<sub>4</sub>) over Silox (SiO<sub>2</sub>)  
 Nitride Thickness: 4.0kÅ +/- 0.5kÅ  
 Silox Thickness: 12.0kÅ +/- 1.3kÅ

**Top Metallization**

Type: AL Si Cu  
 Thickness: 16.0kÅ +/- 2kÅ

**Substrate:**

Radiation Hardened Silicon Gate,  
 Dielectric Isolation

**Backside Finish:**

Silicon

**ASSEMBLY RELATED INFORMATION**

**Substrate Potential:**

Unbiased (DI)

**ADDITIONAL INFORMATION**

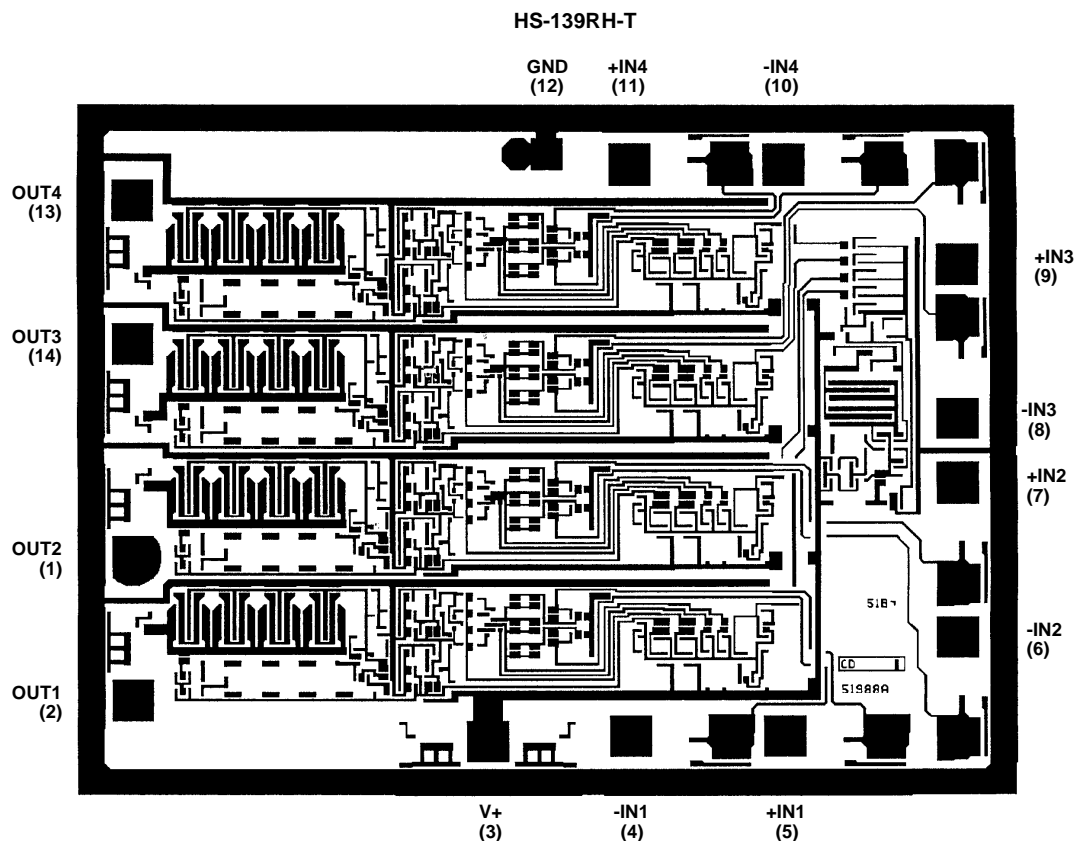
**Worst Case Current Density:**

<2.0 x 10<sup>5</sup> A/cm<sup>2</sup>

**Transistor Count:**

49

**Metallization Mask Layout**



All Intersil U.S. products are manufactured, assembled and tested utilizing ISO9000 quality systems.  
 Intersil Corporation's quality certifications can be viewed at [www.intersil.com/design/quality](http://www.intersil.com/design/quality)

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